



Advanced laser solutions for interconnect and component production.

## ProVia Laser Drilling and RapiTrim Laser Trim and Test Systems

PPI Systems provides a broad range of turn-key solutions to the interconnect and electronic component market for via drilling, circuit processing, trim and test, and high-precision micro-machining.



Blind Via Drilling • Through Hole Via Drilling • Resistor Trimming •  
Buried Via Drilling • Cutting • Routing • Patterning • Skiving  
• Embedded Circuits • Defect Repair

# PPI

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## ProVia Laser Drilling Systems

**ProVia FP-UC Dual-laser Hybrid (UV & CO<sub>2</sub>) System**  
Total process capability in copper clad laminates

**ProVia FP-C Single-laser (CO<sub>2</sub>) System**  
Dielectric and thin copper processing

**ProVia FP-U Single-laser (UV) System**  
Superior drilling and cutting quality in copper and dielectrics



## RapiTrim Laser Resistor Trimming Systems

**RapiTrim Laser Trim and Test Systems**  
Large format system for full-size PCBs

**RapiTrim-C Laser Trim and Test Systems**  
Hybrid circuit trim and test



## ProSys System Software

An intuitive graphical user interface that offers unmatched ease of use for both operators and process engineers. All machine setup and calibration controls, job and process settings, vision and process map, status and diagnostic information are accessible with a single click or tap.

